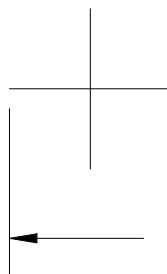



Product functi



Product Dimensions



Reliability Test

							/
Test Parameter	Reference Criterion	Test Condition	Time	Quantity	Ac/RE		
Resistance to Solder Heat	JESD22-B106	260 ±5	10sec	30PCS	0/1		
Thermal Cycle	JESD22-A104	110 (15min) 5min - 15 (15min)	50 cycles	30PCS	0/1		
Thermal Shock	JESD22-A104	120 (30min) - 45 (30min)	50 cycles	30PCS	0/1		
High Temperature storage	JESD22-A103	100	1000H	30PCS	0/1		
Low Temperature storage	JESD22-A119	- 40	1000H	30PCS	0/1		
High Temperature and High Humidity Test	JESD22-A1	d-, m "	λ	λq	" λ		

■ Recommended Solder

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